6 A High-Speed MOSFET Drivers

The NCP4420/NCP4429 are 6 A (peak), single output, MOSFET drivers. The NCP4429 is an inverting driver while the NCP4420 is a non–inverting driver. These drivers are fabricated in CMOS for lower power and more efficient operation versus bipolar drivers.

Both drivers have TTL–compatible inputs, which can be driven as high as $V_{DD} + 0.3 \ V$ or as low as $-5 \ V$ without upset or damage to the device. This eliminates the need for external level shifting circuitry and its associated cost and size. The output swing is rail–to–rail ensuring better drive voltage margin, especially during power up/power down sequencing. Propagational delay time is only 55 nsec (typ.) and the output rise and fall times are only 25 nsec (typ.) into 2500 pF across the useable power supply range.

Unlike other drivers, the NCP4420/NCP4429 are virtually latch-up proof. They can replace three or more discrete components saving PCB area, costs and improving overall system reliability.

Features

- Latch–Up Protected: Will Withstand > 1.5 A Reverse Output Current
- Logic Input Will Withstand Negative Swing Up to 5 V
- ESD Protected (4 kV)
- Matched Rise and Fall Times (25 nsec)
- High Peak Output Current (6 A Peak)
- Wide Operating Range (4.5 V to 18 V)
- High Capacitive Load Drive (10,000 pF)
- Short Delay Time (55 nsec Typ)
- Logic High Input, any Voltage (2.4 V to V_{DD})
- Low Supply Current with Logic "1" Input (450 μA)
- Low Output Impedance (2.5 Ω)
- Output Voltage Swing to within 25 mV of Ground or V_{DD}
- Temperature Range –40°C to +85°C

Applications

- Switch–Mode Power Supplies
- Motor Controls
- Pulse Transformer Driver
- Class D Switching Amplifiers



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MARKING DIAGRAM



SO-8 D SUFFIX CASE 751





PDIP-8 P SUFFIX CASE 626



x = Device Number (0 or 9)

YY. Y = Year

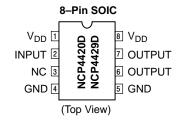
WW = Work Week

X = Assembly ID Code

Z = Subcontractor ID Code

CO = Country of Orgin

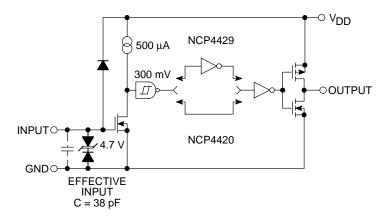
PIN CONNECTIONS



ORDERING INFORMATION

Device	Package	Shipping
NCP4420DR2 Non–Inverting	SO-8	2500 Tape & Reel
NCP4429DR2 Inverting	SO-8	2500 Tape & Reel
NCP4420P Non-Inverting	PDIP-8	50 Units/Rail
NCP4429P Inverting	PDIP-8	50 Units/Rail

FUNCTIONAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS*

Rating	_	Value	Unit
Supply Voltage		+20	V
Input Voltage		–5.0 to V _{DD}	V
Input Current (V _{IN} > V _{DD})	V	50	mA
Power Dissipation, $T_A \le 70^{\circ}C$ SOIC PDIP	0	470 730	mW
Derating Factors (To Ambient) SOIC PDIP),	4.0 8.0	mW/°C
Storage Temperature Range, T _{stg}		-65 to +150	°C
Operating Temperature (Chip)		+150	°C
Operating Temperature Range (Ambient), T _A		-40 to +85	°C
Lead Temperature (Soldering, 10 sec)		+300	°C

^{*}Static—sensitive device. Unused devices must be stored in conductive material. Protect devices from static discharge and static fields. Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS ($T_A = +25^{\circ}C$ with 4.5 V $\leq V_{DD} \leq 18$ V, unless otherwise specified.)

Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit	
Input							
Logic 1 High Input Voltage	V _{IH}	_	2.4	1.8	_	V	
Logic 0 Low Input Voltage	V _{IL}	_	_	1.3	0.8	V	
Input Voltage Range	V _{IN} (Max)	_	-5.0	_	V _{DD} +0.3	V	
Input Current	I _{IN}	$0 \text{ V} \leq \text{V}_{IN} \leq \text{V}_{DD}$	-10	ı	10	μΑ	
Output							
High Output Voltage	V _{OH}	See Figure 1	V _{DD} -0.025	_	-	٧	
Low Output Voltage	V _{OL}	See Figure 1	-	_	0.025	٧	
Output Resistance, High	R _{OH}	I _{OUT} = 10 mA, V _{DD} = 18 V	-	2.1	2.8	Ω	
Output Resistance, Low	R _{OL}	I _{OUT} = 10 mA, V _{DD} = 18 V	_	1.5	2.5	Ω	

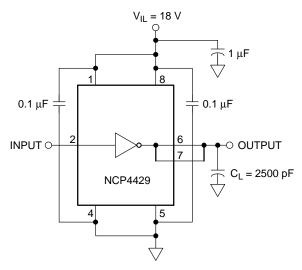
Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Output						
Peak Output Current	I _{PK}	V _{DD} = 18 V (See Figure 5)	-	6.0	_	А
Latch–Up Protection Withstand Reverse Current	I _{REV}	Duty Cycle $\leq 2\%$ t $\leq 300 \mu s$	1.5	-	_	А
Switching Time (Note 1)	•	·				
Rise Time	t _R	Figure 1, C _L = 2500 pF	-	25	35	nsec
Fall Time	t _F	Figure 1, C _L = 2500 pF	-	25	35	nsec
Delay Time 1	t _{D1}	Figure 1	-	55	75	nsec
Delay Time 2	t _{D2}	Figure 1	-	55	75	nsec
Power Supply		·				2
Power Supply Current	I _S	V _{IN} = 3.0 V V _{IN} = 0 V	- -	0.45 55	1.5 150	mA μA
Operating Input Voltage	V _{DD}	-	4.5	-	18	V

^{1.} Switching times guaranteed by design.

ELECTRICAL CHARACTERISTICS (Measured over operating temperature range with $4.5 \text{ V} \leq \text{V}_{DD} \leq 18 \text{ V}$, unless otherwise specified.)

specifica.)						
Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Input						
Logic 1 High Input Voltage	V _{IH}	-	2.4	_	-	V
Logic 0 Low Input Voltage	V _{IL}	-		-	0.8	V
Input Voltage Range	V _{IN} (Max)		-5.0	_	V _{DD} +0.3	V
Input Current	I _{IN}	$0 \text{ V} \leq \text{V}_{\text{IN}} \leq \text{V}_{\text{DD}}$	-10	-	10	μΑ
Output						
High Output Voltage	V _{OH}	See Figure 1	V _{DD} -0.025	_	-	V
Low Output Voltage	V _{OL}	See Figure 1	-	_	0.025	V
Output Resistance, High	R _{OH}	l _{OUT} = 10 mA, V _{DD} = 18 V	-	3.0	5.0	Ω
Output Resistance, Low	R _{OL}	I _{OUT} = 10 mA, V _{DD} = 18 V	_	2.3	5.0	Ω
Switching Time (Note 1)	0),					
Rise Time	lt _R	Figure 1, C _L = 2500 pF	-	32	60	nsec
Fall Time	t _F	Figure 1, C _L = 2500 pF	-	34	60	nsec
Delay Time 1	t _{D1}	Figure 1	-	50	100	nsec
Delay Time 2	t _{D2}	Figure 1	-	65	100	nsec
Power Supply						
Power Supply Current	I _S	$V_{IN} = 3.0 \text{ V}$ $V_{IN} = 0 \text{ V}$		0.45 60	3.0 400	mA μA
Operating Input Voltage	V _{DD}	_	4.5	-	18	V

^{1.} Switching times guaranteed by design.



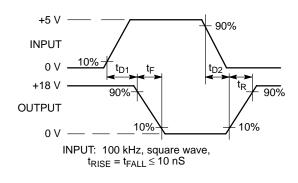


Figure 1. Switching Time Test Circuit

TYPICAL CHARACTERISTICS

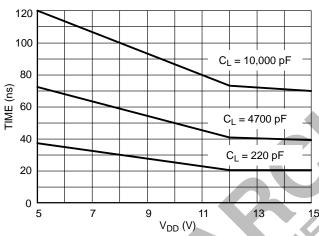


Figure 2. Rise Time vs. Supply Voltage

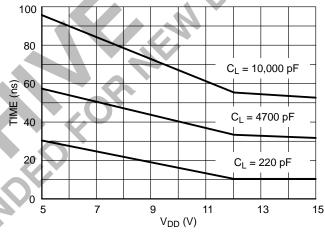


Figure 3. Fall Time vs. Supply Voltage

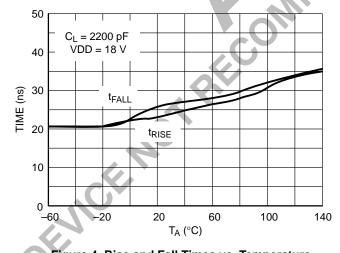


Figure 4. Rise and Fall Times vs. Temperature

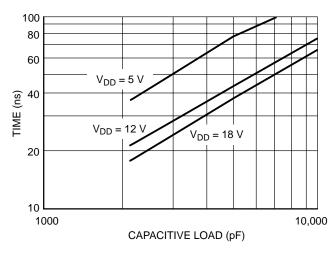


Figure 5. Rise Time vs. Capacitive Load

TYPICAL CHARACTERISTICS

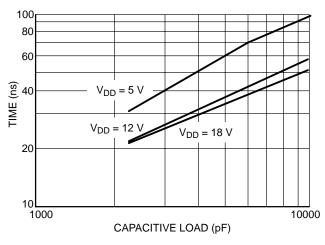


Figure 6. Fall Time vs. Capacitive Load

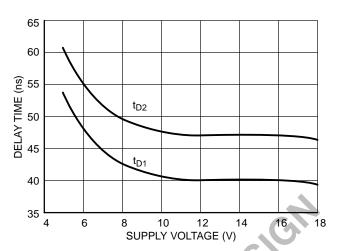


Figure 7. Propagation Delay Time vs.Supply Voltage

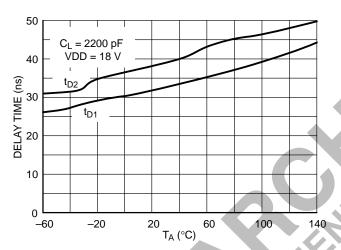


Figure 8. Propagation Delay Time vs. Temperature

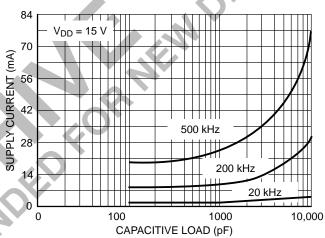


Figure 9. Supply Current vs. Capacitive Load

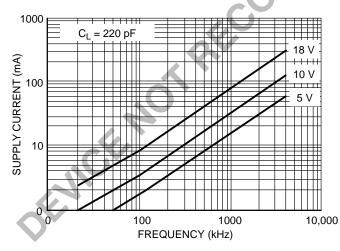


Figure 10. Supply Current vs. Frequency

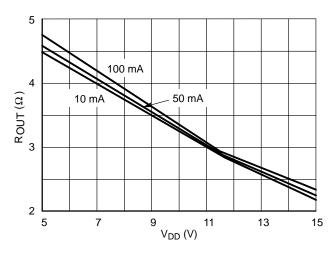
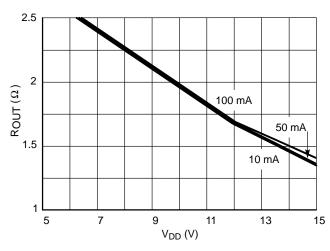


Figure 11. High-State Output Resistance

TYPICAL CHARACTERISTICS



200 LOAD = 2200 pF160 DELAY TIME (ns) 120 INPUT 2.4 V INPUT 3 V 80 JNPUT 5 V 40 INPUT 8 V AND 10 V 0 14 5 6 8 9 10 11 12 15 7 $V_{DD}(V)$

Figure 12. Low-State Output Resistance

Figure 13. Effect of Input Amplitude on Propagation Delay

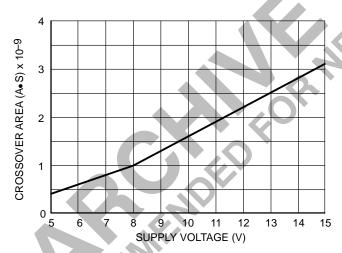
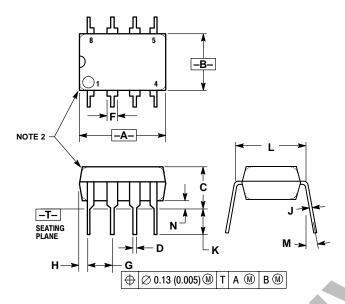


Figure 14. Total nA•S Crossover*

*The values on this graph represent the loss seen by the driver during one complete cycle. For a single transition, divide the value by 2.

PACKAGE DIMENSIONS

PDIP-8 **P SUFFIX** CASE 626-05 ISSUE K

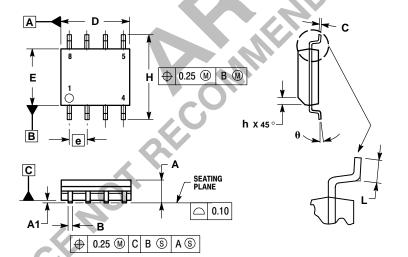


- NOTES:
 1. DIMENSION L TO CENTER OF LEAD WHEN
- FORMED PARALLEL.
 2. PACKAGE CONTOUR OPTIONAL (ROUND OR
- SQUARE CORNERS).

 3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.40	10.16	0.370	0.400
В	6.10	6.60	0.240	0.260
С	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54	BSC	0.100	BSC
Н	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L		BSC		BSC
М		10°		→ 10°
N	0.76	1.01	0.030	0.040
		4	V	
		N	V	

SO-8 **D SUFFIX** CASE 751-06 ISSUE T



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. DIMENSIONS ARE IN MILLIMETER.
 3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTECTION OF AND EDUCATION OF THE PROTECTION OF THE PROTECTION OF THE PROTECTION OF T
- PROTRUSION.

 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN	MAX			
Α	1.35	1.75			
A1	0.10	0.25			
В	0.35	0.49			
С	0.19	0.25			
D	4.80	5.00			
E	3.80	4.00			
е	1.27 BSC				
Н	5.80	6.20			
h	0.25	0.50			
L	0.40	1.25			
Δ	n۰	7 0			



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